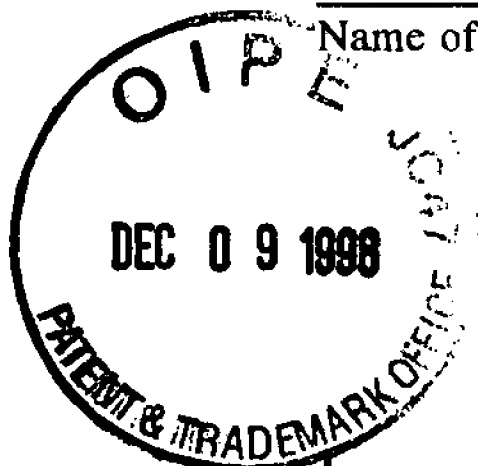


I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on December 7, 1998

Kent E. Genin
Signature

Kent E. Genin, Reg. No. 37,834

Name of applicant, assignee or Registered Representative



PATENT
CASE NO. 7103/30

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Homayoun Talieh et al.

Serial No.: 08/853,323

Filed: May 8, 1997

For: LINEAR POLISHER AND
METHOD FOR
SEMICONDUCTOR WAFER
PLANARIZATION

Examiner: G. Nguyen

Group Art Unit: 3723

RESPONSE AND AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

In response to the Office action dated August 5, 1998 please enter the following amendment and consider the following remarks:

IN THE CLAIMS:

Please cancel claims 23 – 31 without prejudice.

Please amend claims 32, 34, 36-38, and 40 as follows:

Amended
12/18/98
EJGmbf

RECEIVED
DEC 15 1998
Group 3700